



RF ESD Protection Diodes

- ESD protection of RF antenna / interfaces or ultra high speed data lines acc. to: IEC61000-4-2 (ESD): ± 15 KV (air / contact) IEC61000-4-4 (EPT): 40 A (5/50 ns) IEC61000-4-5 (surge): 5 A (8/20 µs)
- Very low line capacitance: 0.4 pF @ 1 GHz
 (0.2 pF per diode)
- Ultra low series inductance: 0.4 nH per diode
- Very low clamping voltage
- Ultra small leadless package:1.2 x 0.8 x 0.39 mm³
- Pb-free (RoHS compliant) package

Applications in anti-parallel configuration

 For low RF signal levels without superimposed DC voltage: e.g. GPS, XM-Radio, Sirius, DVB, DMB, DAB, Remote Keyless Entry

Applications in rail-to-rail configuration

 For high RF signal levels or low RF signal levels with superimposed DC voltage: e.g. HDMI, S-ATA, Gbit Ethernet

RoHS	/
	,

ESD0P4RFL



Туре	Package	Configuration	Marking
ESD0P4RFL	TSLP-4-7	anti-parallel	E4





Maximum Ratings at $T_A = 25^{\circ}$ C, unless otherwise specified

Parameter	Symbol	Value	Unit		
ESD contact discharge ¹⁾	V _{ESD}	15	kV		
Peak pulse current ($t_p = 8 / 20 \ \mu s$) ²⁾	I _{pp}	5	A		
Operating temperature range	T _{op}	-55150	°C		
Storage temperature	T _{stg}	-65150			

Electrical Characteristics at $T_A = 25^{\circ}C$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics -					
Reverse working voltage ³⁾	V _{RWM}	-	-	50	V
Reverse current ³⁾	I _R	-	20	100	nA
V _R = 50 V					
Forward clamping voltage ²⁾	V _{FC}	-	6	9	V
I _{PP} = 5 A					
Diode capacitance ⁴⁾	CT	-	0.4	-	pF
<i>V</i> _R = 0 V, <i>f</i> = 1 GHz					
Series inductance per diode	L _S	-	0.4	-	nH

¹V_{ESD} according to IEC61000-4-2, only valid in anti-parallel or rail-to-rail connection.

Please refer to the application examples.

 $^{2}I_{pp}$ according to IEC61000-4-5, only valid in anti-parallel or rail-to-rail connection.

Please refer to the application examples.

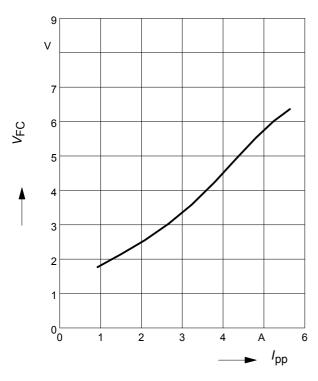
³Only valid in rail-to-rail configuration with $V_{CC} \le V_{RWM}$

⁴Total capacitance line to ground (2 diodes in parallel)



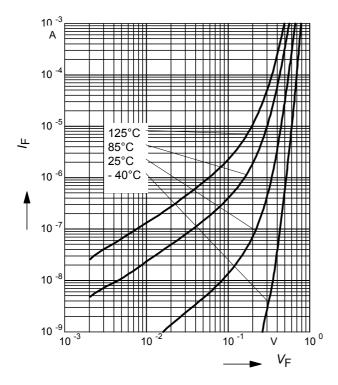
Forward clamping voltage $V_{FC} = f(I_{PP})$

 $t_{\rm p}$ = 8 / 20 µs



Forward current $I_F = f(V_F)$

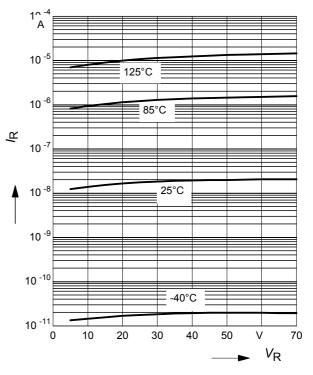
leakage in anti-parallel configuration



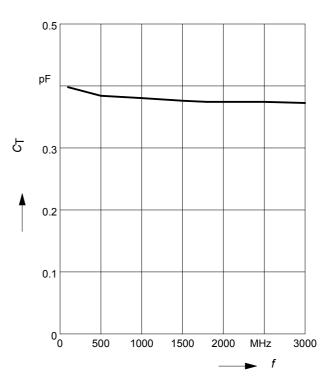
Reverse current $I_{R} = f(V_{R})$

 T_A = Parameter

leakage in rail-to-rail configuration



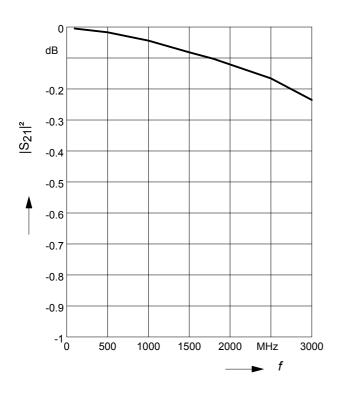
Line capacitance $C_{\mathsf{T}} = f(\mathsf{f})$ $V_{\mathsf{R}} = 0 \; \mathsf{V}$







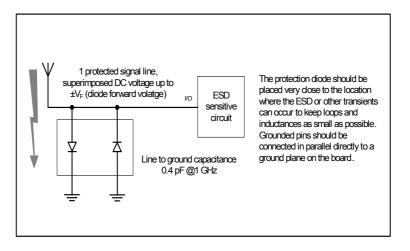
$Insertion \ loss \ l_L = -|S_{21}|^2 = f(f) \\ V_R = 0 \ V, \ Z = 50 \ \Omega$





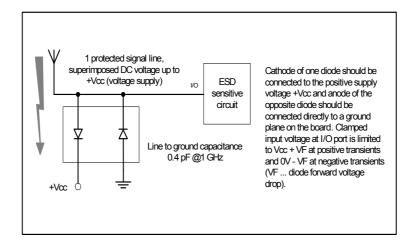
1. Application example ESD0P4RFL

1 RF signal channel, anti-parallel configuration

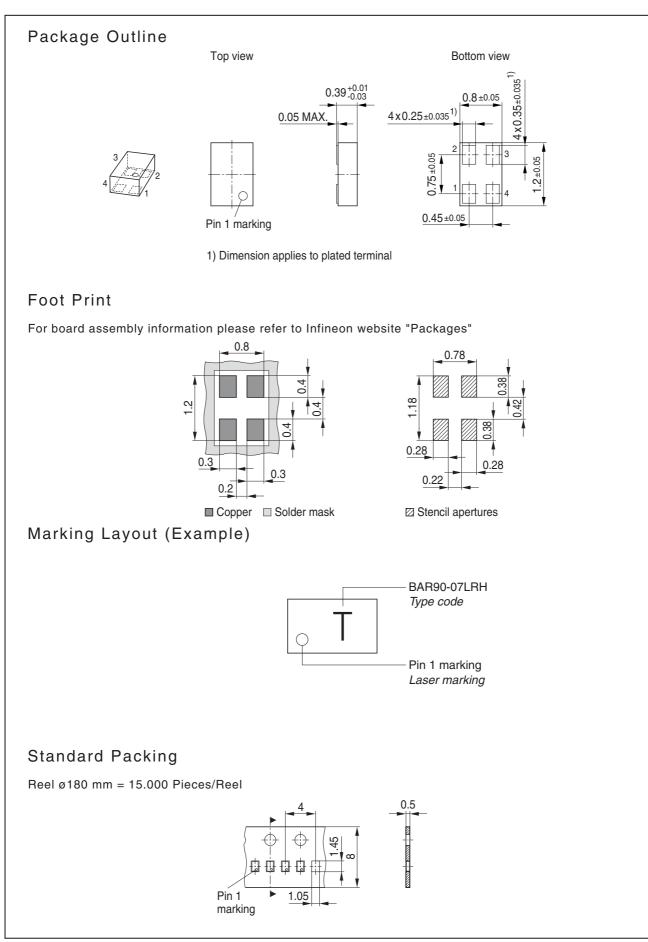


2. Application example ESD0P4RFL

1 RF signal channel, rail-to-rail configuration











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